



COATINGS PART I: PLATED & CONVERSION COATINGS

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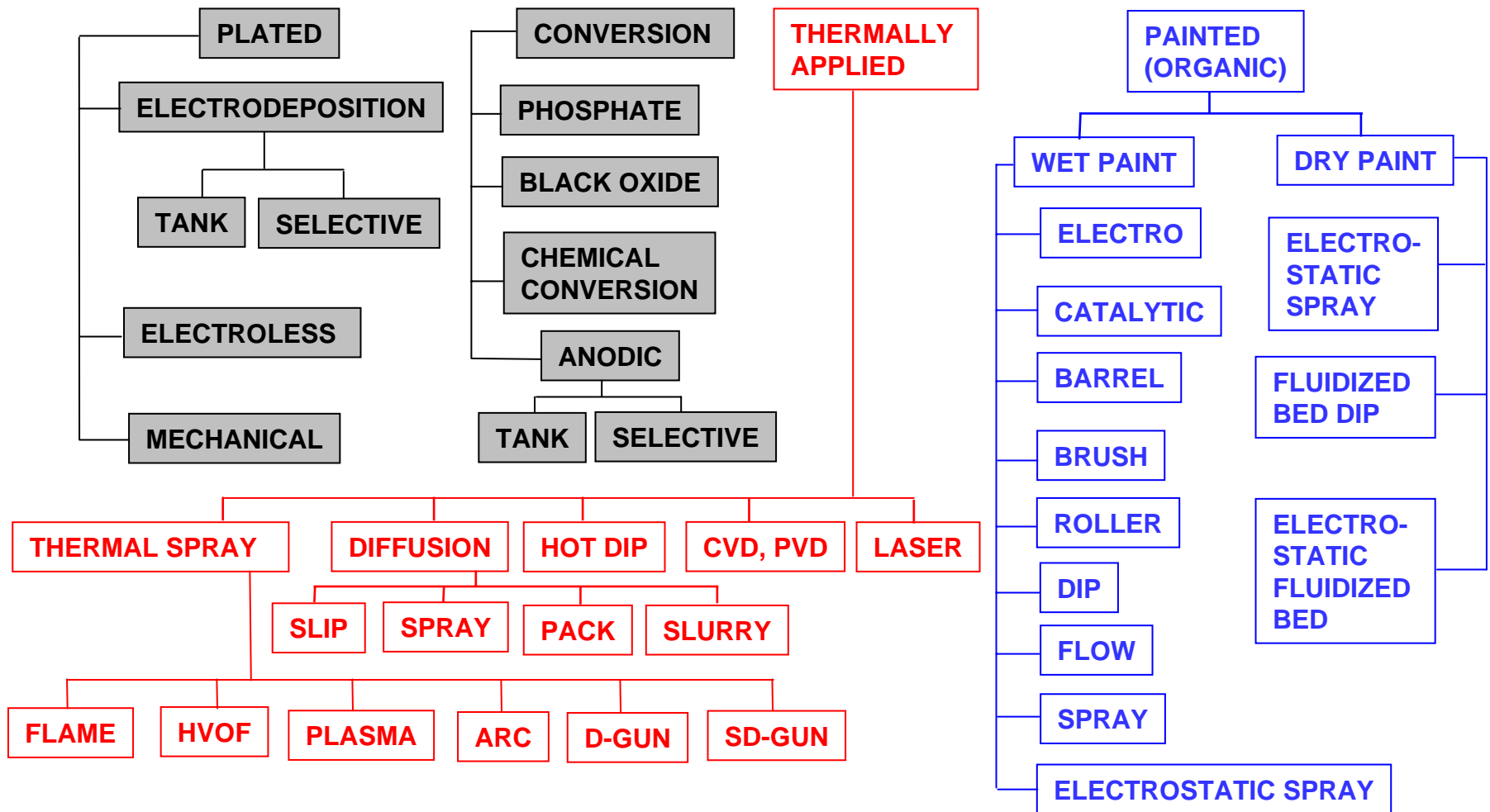
WHY COAT?

FOR ONE OR MORE OF FOLLOWING REASONS:

- ① TO PROVIDE CORROSION PROTECTION**
- ② TO ACHIEVE GALVANIC COMPATIBILITY**
 - ⊙ E.G., Cd ON STAINLESS IN CONTACT WITH ALUMINUM
- ③ TO PROMOTE / IMPROVE SPECIFIC CHARACTERISTICS**
 - ⊙ CASE: ACHIEVE EMC (ELECTROMAGNETIC COMPATIBILITY)
 - ⊗ E.G., ELECTROLESS Ni ON MATING ALUMINUM DETAILS
 - ⊙ CASE: COMPLY WITH OPTICAL / COLOR REQUIREMENTS
 - ⊗ E.G., PAINTING, COLOR ANODIZING
 - ⊙ CASE: PROMOTE ADHESION
 - ⊗ E.G., PHOSPHATE BEFORE PAINT
 - ⊙ CASE: IMPROVE WEAR RESISTANCE:
 - ⊗ E.G., HARD ANODIZE ON ALUMINUM
 - ⊙ CASE: PROVIDE LUBRICATION
 - ⊗ E.G., Ag ON FASTENERS FOR ELEVATED TEMPERATURES
- ④ TO SALVAGE / REPAIR DAMAGED / WORN DETAILS**

COATINGS

BY METHOD OF APPLICATION

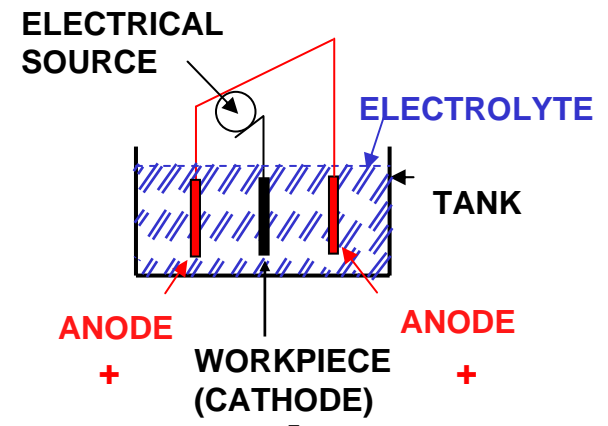
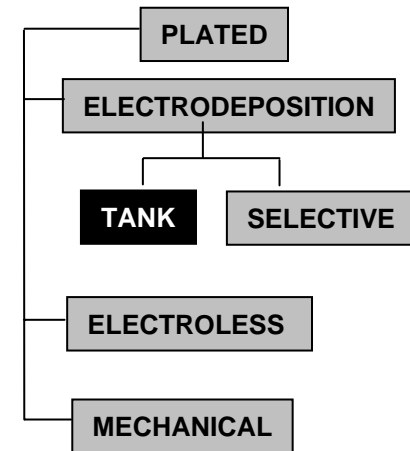


PLATED COATINGS

TANK ELECTRODEPOSITION



- ❖ MOST METALS & MANY ALLOYS ELECTRODEPOSITED
 - ❖ ON OTHER METALS & ALLOYS
- ❖ ELECTRICAL SOURCE
- ❖ ELECTROLYTE
- ❖ CATHODE: WORKPIECE BEING PLATED
- ❖ ANODE: TWO TYPES
 - ❖ SOLUBLE ANODE: DISSOLVES TO PROVIDE PLATING ION(S)
 - ◆ E.G., Ni, Cd, Cu, Zn, Sn
 - ❖ INSOLUBLE ANODE: PLATING IONS COME FROM ELECTROLYTE
 - ◆ E.G., Cr, Ag



PLATED COATINGS

TANK ELECTRODEPOSITION



- ❖ **COMPOSITE ELECTRODEPOSITION POSSIBLE- PROPRIETARY**
 - ❖ **PARTICLES SUSPENDED IN ELECTROLYTE**
 - ◆ **Ni-WC: WC PARTICLES SUSPENDED IN WATTS Ni BATH**
 - ◆ **Cr-GRAPHITE: GRAPHITE PARTICLES SUSPENDED IN CONVENTIONAL Cr BATH**
 - ❖ **ALLOY (Ni-Cr, Ni-Co) PLATING, FOLLOWED BY PTFE INFUSION**
 - ◆ **AKA SYNERGISTIC COATINGS**

- ❖ **LAYERED ELECTRODEPOSITS - DEVELOPMENTAL STAGE**
 - ❖ **FOR ELECTRONIC, MAGNETIC, MECHANICAL & ELEVATED TEMPERATURE APPLICATIONS**

- ❖ **SURFACE PREPARATION CRUCIAL**
 - ❖ **FOR ADEQUATE ADHESION OF ELECTRODEPOSITS, SURFACES MUST BE PROPERLY CLEANED**
 - ◆ **MECHANICALLY AND/OR CHEMICALLY**

TANK ELECTRODEPOSITION NOTES OF CAUTION

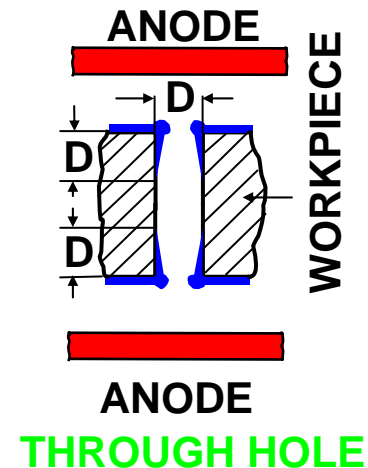
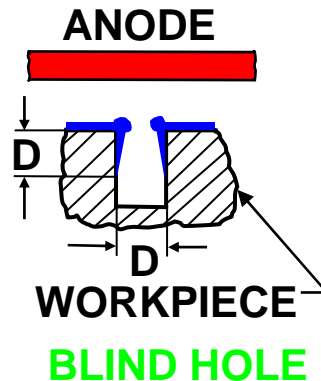


- ❖ **DIFFICULT TO PLATE ON Al, Ti & STAINLESS ALLOYS**
 - ❖ **SURFACE OXIDE LAYER**
 - ❖ **CLEAN IMMEDIATELY BEFORE PLATING**
 - ◆ **Al: ZINCATE AFTER CLEANING**

- ❖ **DEPOSIT THICKNESS VARIES**
 - ❖ **EDGES: MORE BUILDUP**
 - ◆ **HIGH CURRENT DENSITY**
 - ❖ **THROWING POWER → DEPTH OF COVERAGE**
LIMITATIONS
 - ◆ **THICKNESS ↓ WITH DISTANCE FROM ANODE**
 - ◆ **E.G., HOLES, RECESSES**
 - ◆ **BEYOND CERTAIN DISTANCE (DEPTH)-NO COVERAGE**

TANK ELECTRODEPOSITION

NOTES OF CAUTION



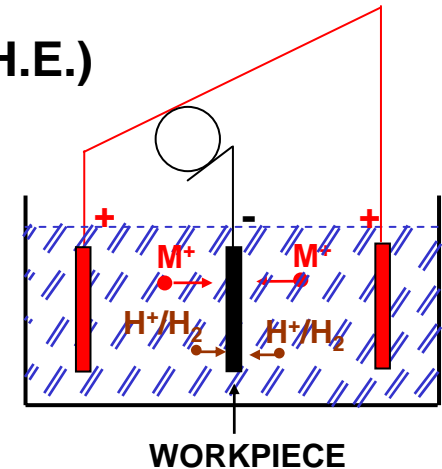
- ❖ **THICKNESS VARIATION & DEPTH OF COVERAGE**
 - ❖ **DEPEND ON OPERATING CONDITIONS**
 - ❖ **DEPTH ESTIMATE FOR HOLES: 1 D OR LESS**
- ❖ **USE CONFORMING / SPECIAL ANODES & THIEVES**
 - ❖ **FOR BETTER UNIFORMITY**

TANK ELECTRODEPOSITION

NOTES OF CAUTION-HYDROGEN



- ❖ H_2 GENERATED DURING ELECTRODEPOSITION
- ❖ AT WORKPIECE (-)
- ❖ CAN CAUSE “HYDROGEN EMBRITTLEMENT” (H.E.)
- ❖ FOR STEELS
 - ❖ SUSCEPTIBILITY TO H.E. ↑ AS
 - ◆ HARDNESS / STRENGTH ↑
 - ◆ RESIDUAL TENSILE STRESS ↑
- ❖ H.E. RELIEF PROVISIONS
 - ❖ STRESS RELIEVE BEFORE PLATING
 - ◆ TO REDUCE RESIDUAL STRESSES
 - AND
 - ❖ BAKE AFTER PLATING
 - ◆ WITHIN A SPECIFIED TIME AFTER PLATING
 - ◆ TYPICALLY 4 Hrs
 - ◆ TO REDISTRIBUTE / REDUCE H_2 LEVEL



TANK ELECTRODEPOSITION

NOTES OF CAUTION-HYDROGEN



- ❖ **STRESS RELIEF & BAKE (CARBON, ALLOY, TOOL & PH STEELS)**
 - ❖ **REQUIRED WHEN HARDNESS / STRENGTH > SET VALUE**
 - ◆ **SET VALUE: DEPENDS ON SPECIFICATION**
 - ◆ **MOST IN HRC 35-40 (F_{tu} 150-180 KSI) RANGE**
 - ❖ **TEMPERATURE: LOWER THAN FINAL TEMPERING / AGING**
 - ◆ **INDUSTRY PRACTICE: 375 F**
 - ◆ **800 F & HIGHER POSSIBLE FOR PH STAINLESS STEELS**
 - ❖ **TIMES: STRESS RELIEF, 3-8 HRS; BAKE, 3-23 HRS**
 - ◆ **DEPENDING ON**
 - ◆ **PLATING SPECIFICATION**
 - ◆ **REVISION OF PARTICULAR SPECIFICATION**

- ❖ **STRESS RELIEF REQUIRED ONLY IF PARTS WERE MACHINED OR FORMED AFTER TEMPERING / AGING**
 - ❖ **SOME SPECIFICATIONS FOLLOW THE SET VALUE APPROACH**
 - ❖ **OTHERS MANDATE IT FOR FOR ALL PARTS**

TANK ELECTRODEPOSITION

NOTES OF CAUTION-HYDROGEN



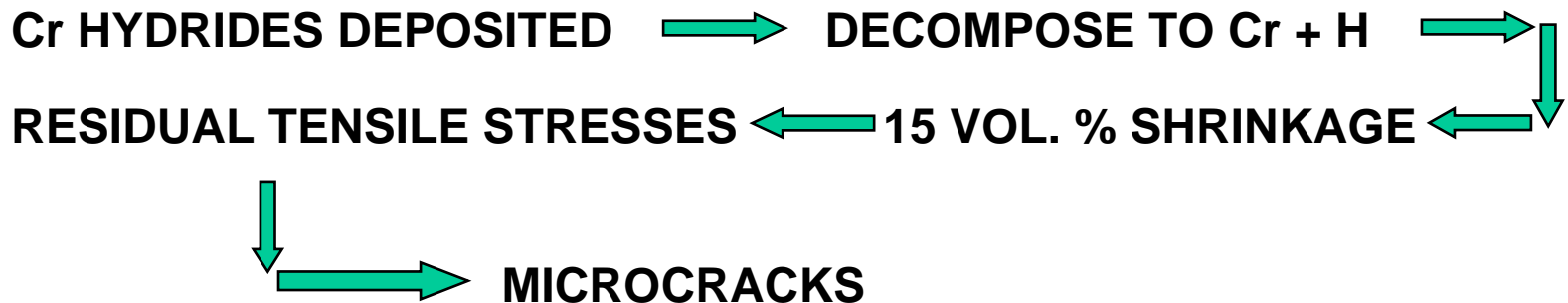
**WARNING: H.E. RELIEF PROVISIONS NOT
BASED ON SOLID, REPRODUCIBLE DATA**

- ❖ THE SMART WAY IS TO FOLLOW THE CONTROLLING SPECIFICATION
- ❖ IF YOU DO NOT STRESS RELIEVE BEFORE PLATING
 - ❖ IT IS OF NO USE TO DO IT AFTER PLATING
 - ❖ THE HARDWARE IS SUSPECT
- ❖ IF YOU DO NOT BAKE WITHIN SET TIME AFTER PLATING
 - ❖ IT IS NO HELP TO DO IT LATER
 - ❖ THE HARDWARE IS SUSPECT
- ❖ IF YOU USE LOWER TEMPERATURES AND / OR SHORTER TIMES
 - ❖ THE HARDWARE IS SUSPECT
 - ❖ DIFFICULT TO SHOW OTHERWISE
- ❖ WHEN THE HARDWARE IS SUSPECT
 - ❖ THERE REALLY IS NO CORRECTIVE ACTION

TANK ELECTRODEPOSITION HARD Cr PLATING



- ❖ AKA ENGINEERING / FUNCTIONAL Cr
 - ❖ SAME BATH AS FOR DECORATIVE Cr
 - ◆ ELECTROLYTE: CHROMIC ACID + VARIOUS SALTS
 - ◆ INSOLUBLE ANODES
- ❖ FOR WEAR APPLICATIONS & SALVAGE / REPAIR
 - ❖ THICKNESS: 0.001-0.020 IN (1-20 MILS) OR THICKER
 - ❖ AS DEPOSITED HARDNESS: HRC 67 OR HIGHER
 - ❖ LOW FRICTION
- ❖ DEPOSIT ORDINARILY CONTAINS MICROCRACKS
 - ❖ BELIEVED DUE TO COATING VOLUME SHRINKAGE:

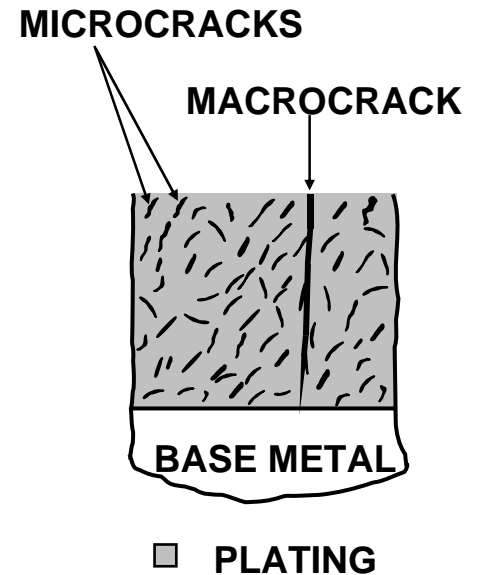


TANK ELECTRODEPOSITION HARD Cr PLATING



- ❖ **MICROCRACKS**
 - ❖ **NO ADVERSE EFFECT ON CORROSION PROTECTION**
 - ◆ **DO NOT LINE UP**
 - ◆ **NO PATH FROM TOP TO INTERFACE**
 - ❖ **RESIDUAL TENSILE STRESSES**
 - ◆ **NOT FULLY RELIVED**
 - ◆ **∴ FATIGUE DEBIT**

- ❖ **MACROCRACKS**
 - ❖ **ADVERSELY AFFECT CORROSION RESISTANCE**
 - ◆ **FROM TOP TO INTERFACE, LONGER, WIDER**
 - ❖ **RESULT FROM**
 - ◆ **PLATING CONDITIONS**
 - ◆ **PRECOATING RESIDUAL STRESSES**
 - ◆ **THERMAL SHOCK AFTER PLATING**



TANK ELECTRODEPOSITION HARD Cr PLATING



- ❖ PROBLEMS WITH Cr PLATING
 - ① NOT ENVIRONMENTALLY FRIENDLY
 - ② LONG PROCESSING TIMES
 - ☹ SLOW DEPOSITION RATES (ABOUT 0.001 IN / HR)
 - ☹ H.E. PROVISIONS FOR STEELS
 - ☺ NOT JUST Cr BUT ALL OTHER PLATES
 - ③ FATIGUE DEBIT
 - ④ INCONSISTENT CORROSION PROTECTION
 - ☹ DUE TO MACROCRACKS
 - ☺ CAN BE AVOIDED
- ❖ Cr REPLACEMENT EFFORTS UNDERWAY GLOBALLY
 - ☒ COMPOSITE Co-WC, Co-Cr-WC COATINGS
 - * THERMALLY SPRAYED
 - ➡ BY HVOF (HIGH VELOCITY OXY-FUEL)
- ❖ Cr WILL NOT GO AWAY
 - THERMAL SPRAY LIMITATIONS

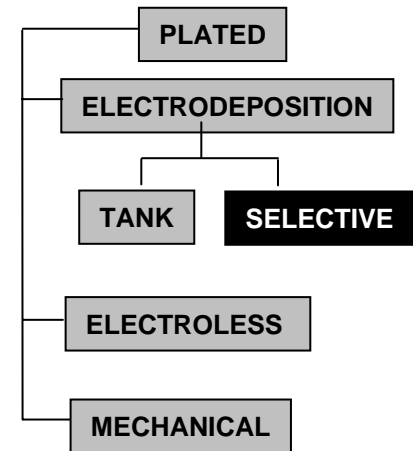


PLATED COATINGS

SELECTIVE ELECTRODEPOSITION

- ❖ LOCALIZED ELECTRODEPOSITION
 - ❖ AKA STYLUS / BRUSH PLATING
- ❖ NO DIPPING IN TANK
 - ❖ ELECTROLYTE BROUGHT TO STYLUS (ANODE)
 - ❖ STYLUS HAS ABSORBENT WRAPPING
- ❖ USED FOR Cr, Ni, Cd, Cu & OTHER METALS
 - ❖ CLEAN SURFACES CRUCIAL FOR ADHESION
- ❖ ATTRACTIVE WHEN PLATED AREA IS SMALL
 - ❖ MINIMUM MASKING REQUIRED
- ❖ MAY BE USED FOR SALVAGE & REPAIR

- ❖ H.E. PROVISIONS APPLY FOR STEELS
 - ❖ EXCEPT FOR SPECIFIC PLATING SOLUTIONS: LHE Cd (Cd-Ni), Ni-W
- ❖ SELECTIVE PROCESSES ALSO USED FOR ANODIZING, ELECTRO- STRIPPING / MILLING / POLISHING / ETCHING
 - ❖ STYLUS ANODE OR CATHODE, AS REQUIRED

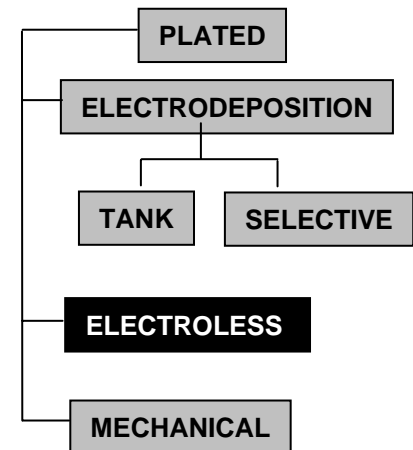


PLATED COATINGS

ELECTROLESS PLATING



- ❖ BY CATALYTIC REDUCTION REACTION
 - ❖ NO ELECTRIC SOURCE REQUIRED
 - ❖ DIPPING IN TANK REQUIRED
- ❖ CAN PLATE ON METALS AND NONMETALS (E.G., PLASTICS)
- ❖ COATING IS UNIFORM
 - ❖ NO EDGE BUILDUP OR DEPTH OF COVERAGE LIMITATIONS
- ❖ CLEAN SURFACES CRUCIAL FOR ADHESION
 - ❖ FOR ALUMINUM
 - ◆ BEST TO ZINCATE AFTER CLEANING
 - ◆ NOT MANDATORY IN SOME SPECIFICATIONS ☹
- ❖ H₂ GENERATED
 - ❖ NOT AS MUCH AS IN ELECTRODEPOSITION
 - ❖ STILL A PROBLEM
 - ❖ FOR STEELS: H.E. RELIEF PROVISIONS APPLY



ELECTROLESS PLATING TYPES



- ❖ **SINGLE METAL PLATING**
 - ❖ **Cu, Au, Pd FOR ELECTRONIC APPLICATIONS**

- ❖ **ALLOY PLATING**
 - ❖ **Ni-P (CONVENTIONAL ELECTROLESS Ni), Ni-B, Co-B, Ni-Mo-P, Co-Mo-P, OTHERS**

- ❖ **COMPOSITE PLATING- PROPRIETARY**
 - ❖ **PARTICLES SUSPENDED IN ELECTROLYTE**
 - ◆ **SOFT PARTICLES (LUBRICANTS)**
 - ◆ **E.G., PTFE- AKA SYNERGISTIC COATINGS**
 - ◆ **HARD PARTICLES**
 - ◆ **CARBIDES, CERAMICS OR DIAMOND**
 - ❖ **ELECTROLESS PLATING FOLLOWED BY PTFE INFUSION**
 - ◆ **AKA SYNERGISTIC COATINGS**

- ❖ **NOT AS MANY CHOICES AS IN ELECTRODEPOSITION**

ELECTROLESS PLATING

CONVENTIONAL ELECTROLESS NICKEL



- ❖ **MOST WIDELY USED ELECTROLESS PLATING**
 - ❖ **SODIUM HYPOPHOSPHITE SOLUTION**
 - ❖ **FOR STEEL & ALUMINUM**

- ❖ **ALLOY OF Ni & P**
 - ❖ **HIGH HARDNESS-LOW FRICTION**
 - ◆ **GOOD FOR WEAR APPLICATIONS**
 - ❖ **GENERALLY POROUS**
 - ◆ **FOR ADEQUATE CORROSION PROTECTION, NEED 0.0015 IN. MIN.**

- ❖ **P CONTENT DETERMINES PROPERTIES**
 - ❖ **LOW P: HIGH HARDNESS, LOW CORROSION RESISTANCE, HIGH RESIDUAL TENSILE STRESSES (FATIGUE DEBIT)**
 - ❖ **HIGH P: LOW HARDNESS, HIGH CORROSION RESISTANCE, LOW RESIDUAL TENSILE STRESSES (COMPRESSIVE ABOVE 11% P)**

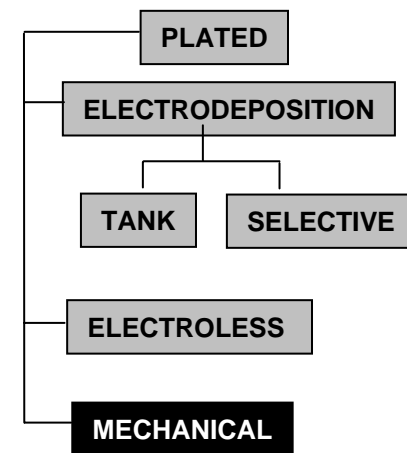
- ❖ **AGING: HIGHER HARNES& LOWER CORROSION RESISTANCE**
 - ❖ **E.G., HIGH P (8-10%) ELECTROLESS Ni**
 - ◆ **AS DEPOSITED HRC 46-52**
 - ◆ **HARDNESS OVER 70 HRC AFTER 750 F / 1 HR AGE**



PLATED COATINGS

MECHANICAL PLATING

- ❖ AKA PEEN / IMPACT / BARREL PLATING, MECHANICAL GALVANIZING
- ❖ FOR APPLYING
 - ❖ MALLEABLE (SOFT) METAL OR ALLOY COATINGS
 - ◆ Pb, Zn, Cd, Sn, Cu, Al, COMBINATIONS
 - ◆ IN POWDER FORM
 - ❖ ONTO STEEL AND Cu ALLOY PARTS
 - ◆ APPLIED @ ROOM TEMPERATURE
 - ◆ NO ELECTRICAL CURRENT
- ❖ PARTS TUMBLED IN BARREL WITH
 - ❖ PEENING MEDIUM
 - ◆ GLASS BEADS, METAL SHOT
 - ❖ CHEMICALS
 - ◆ TO PROMOTE ADHESION
 - ❖ COATING POWDER(S)
 - ❖ WATER
 - ◆ CARRIER



PLATED COATINGS

MECHANICAL PLATING



- ❖ BEADS / SHOT PROVIDE HAMMERING ENERGY
 - ❖ POUND COATING MATERIAL AGAINST PART SURFACES
 - ◆ ADHESION BY COLD WELDING
- ❖ CLEAN SURFACES ESSENTIAL
 - ❖ JUST LIKE ALL PLATING PROCESSES
- ❖ THIN Cu LAYER BARREL PLATED BEFORE DESIRED COATING
 - ❖ TO PROMOTE ADHESION
- ❖ SOME H₂ GENERATED BUT NOT TRAPPED
 - ❖ H.E. NOT A PROBLEM
- ❖ HOLES PLATED IF BEADS OR SHOT CAN GET IN
- ❖ FOR SMALL PARTS & MASS PRODUCTION
 - ❖ FASTENERS, COIL SPRINGS, TORSION BARS
- ❖ GENERALLY NOT FOR PRECISION PARTS
- ❖ VARIANT WITH MESH
 - ❖ ELECTROMECHANICAL
 - ◆ H.E. PROVISIONS APPLY FOR STEELS



CONVERSION COATINGS

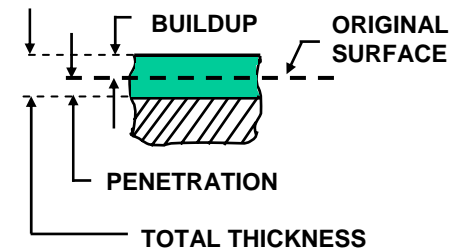
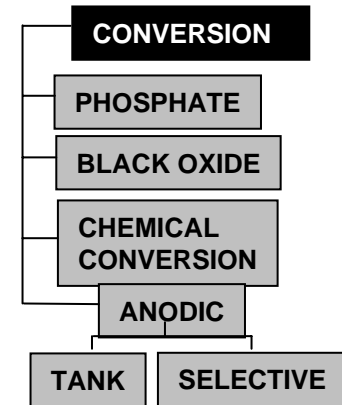
- ❖ **FORMED BY DISSOLVING METAL & DEPOSITING LAYER**
 - ❖ **LAYER INTEGRAL**
 - ◆ **PENETRATION + BUILD UP**

- ❖ **TWO MAJOR CLASSES OF COATINGS**
 - ❖ **CHEMICALLY APPLIED**
 - ◆ **DIP, SPRAY AND / OR BRUSH**
 - ◆ **PHOSPHATE, BLACK OXIDE, CHEMICAL CONVERSION COATINGS**
 - ❖ **ELECTROCHEMICALLY APPLIED**
 - ◆ **ANODIC COATINGS (ANODIZING)**
 - ◆ **ELECTRICAL SOURCE NEEDED**

- ❖ **GOOD AS PAINT BASE**

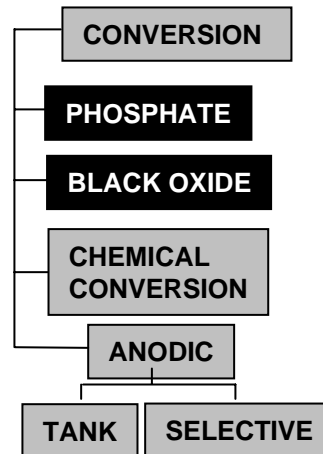
- ❖ **COATINGS GENERALLY POROUS TO VARIOUS DEGREES**

- ❖ **OFFER VARIOUS DEGREES OF CORROSION PROTECTION**



CONVERSION COATINGS

BLACK OXIDE & PHOSPHATE COATINGS



BLACK OXIDE

- ❖ FOR STEELS, STAINLESS STEELS, Al, Cu, Zn, Cd
- ❖ DIP IN HOT OXIDIZING SALTS
 - ❖ FORM THIN OXIDE LAYER
- ❖ THIN: < 0.0001IN. (< 0.1MIL)

PHOSPHATE

- ❖ FOR STEELS, Al, Zn, Cd
- ❖ DIP, SPRAY
 - ❖ PHOSPHORIC **ACID** + SALTS
 - ❖ FORM PHOSPHATE LAYER
- ❖ STEELS: H.E. RELIEF PROVISIONS APPLY (BECAUSE OF THE **ACID**)
- ❖ THIN 0.0001-0.002 IN. (0.1-2.0 MIL)

CONVERSION COATINGS

BLACK OXIDE & PHOSPHATE COATINGS



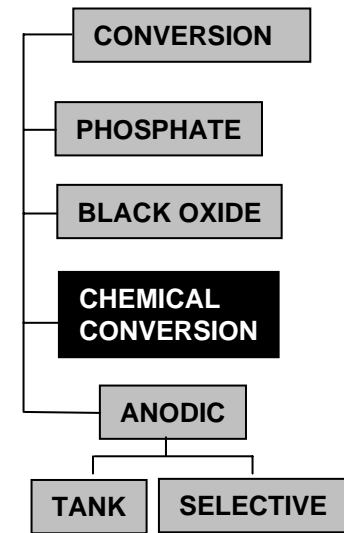
- ❖ NOT ADEQUATE FOR LONG TERM CORROSION PROTECTION
 - ❖ PHOSPHATE GENERALLY BETTER-THICKER PHOSPHATE BEST
- ❖ IMPROVE PROTECTION BY
 - ❖ SUPPLEMENTARY OIL OR LUBRICANTS
- ❖ PHOSPHATE + SOLID FILM LUBRICANT / OIL ON STEELS
 - ❖ COMMON IN WEAR APPLICATIONS
 - ❖ GOOD CORROSION PROTECTION



CONVERSION COATINGS

CHEMICAL CONVERSION COATINGS

- ❖ FOR Al, Mg, Be, Cd, Zn, Sn, Cu
 - ❖ YELLOW COLOR ON Al-ALLOYS & Cd PLATED HARDWARE
- ❖ APPLY BY BRUSH, SPAY OR DIP
 - ❖ CHROMIC ACID + Cr SALTS OR ACIDS
 - ❖ FORM CHROMATE LAYER
- ❖ TOO THIN 0.000005-0.00001 IN. (0.005-0.010 MIL)
- ❖ WATER SOLUBLE – REMOVED BY ERASER
- ❖ NOT ADEQUATE FOR LONG TERM CORROSION PROTECTION
- ❖ CHROMATE NOT ENVIRONMENTALLY FRIENDLY



CONVERSION COATINGS

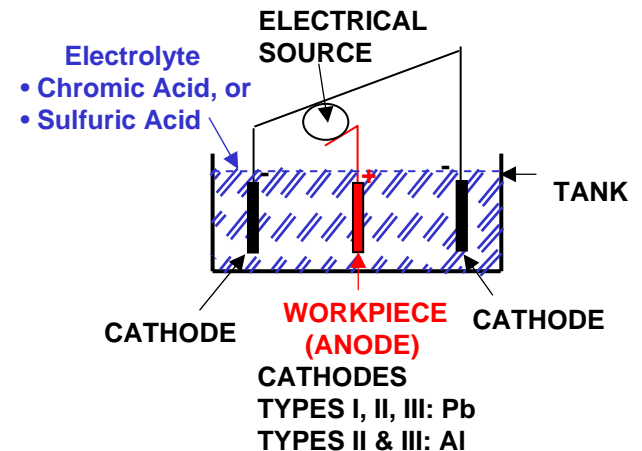
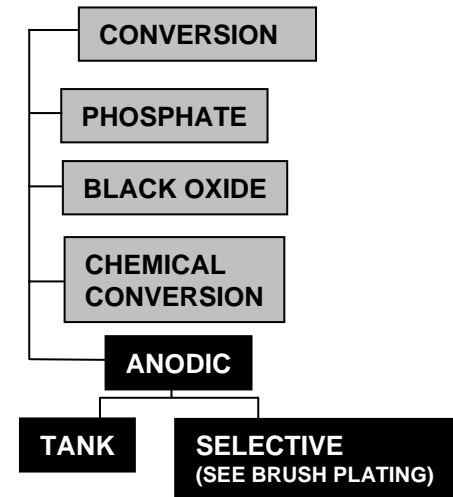
ANODIC COATINGS



- ❖ **ELECTROCHEMICAL CONVERSION**
 - ❖ **FORM OXIDE LAYER**
 - ❖ **FOR Al, Be, Ti, Zn**

ALUMINUM ANODIZING

- ❖ **THREE MAIN TYPES**
 - ❖ **TYPES I, II**
 - ◆ **FOR CORROSION PROTECTION**
 - ❖ **TYPE III**
 - ◆ **FOR WEAR APPLICATIONS**
- ❖ **SUPERIOR TO CHROMATE CONVERSION COATINGS**
 - ❖ **IN PROTECTION & DURABILITY**
- ❖ **EASIER THAN PLATING**
 - ❖ **NO ZINCATE**

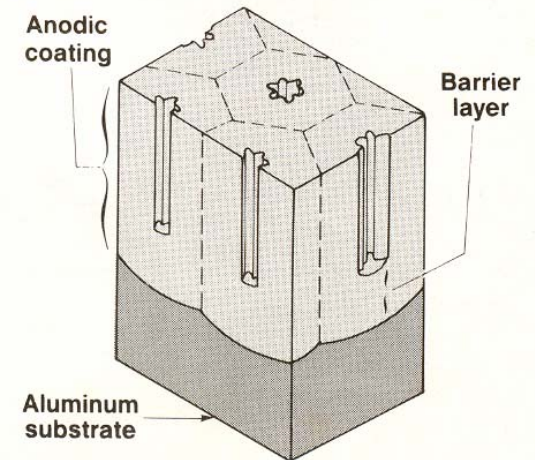


CONVERSION COATINGS

ANODIC COATINGS - ALUMINUM



- ❖ DYING & SEALING POSSIBLE
- ❖ SEQUENCE
 - ① ANODIZE
 - ② DYE FOR COLOR
 - ◆ IF POSSIBLE, REQUIRED
 - ③ SEAL
 - ◆ IN BOILING DI WATER OR ACIDIFIED HOT WATER
 - ◆ ONLY IF PERMITTED
- ❖ SEALING CAUSES COATING TO EXPAND & CLOSE PORES
 - ❖ IMPROVES CORROSION PROTECTION
 - ❖ ADVERSELY AFFECTS
 - ◆ PAINT ADHESION
 - ◆ WEAR PERFORMANCE



CONVERSION COATINGS

ANODIC COATINGS - ALUMINUM



TYPE I: CHROMIC ACID

- ❖ **THICKNESS: 0.00002-0.0007 IN.**
 - ❖ **0.02-0.7 MIL**

- ❖ **NOT SUITABLE FOR ALLOYS**
 - ❖ **WITH Cu > 5 %**
 - OR**
 - ❖ **WITH TOTAL ALLOYING ELEMENTS > 7.5 %**

- ❖ **NOT ENVIRONMENTALLY FRIENDLY**

- ❖ **DIFFICULT / IMPOSSIBLE TO DYE**

- ❖ **MAY BE SEALED**

TYPE II: SULFURIC ACID

- ❖ **THICKNESS: 0.00007-0.0010 IN.**
 - ❖ **0.07-1.0 MIL**

- ❖ **PORES**
 - ❖ **LARGER THAN TYPE I**

- ❖ **MAY BE DYED**
 - ❖ **MANY COLORS**

- ❖ **BRIGHT ANODIZE POSSIBLE**
 - ❖ **GET Cr-LIKE FINISH**
 - ◆ **SOME ALLOYS**
 - ◆ **ONLY IF POLISHED**

- ❖ **MAY BE SEALED**

CONVERSION COATINGS

ANODIC COATINGS - ALUMINUM



TYPE III: HARD ANODIZE

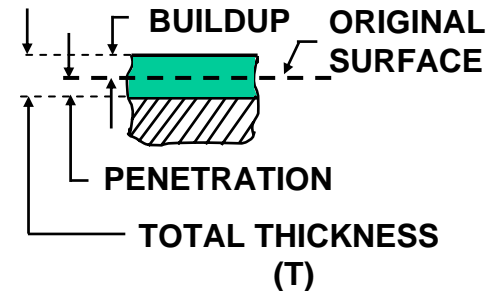
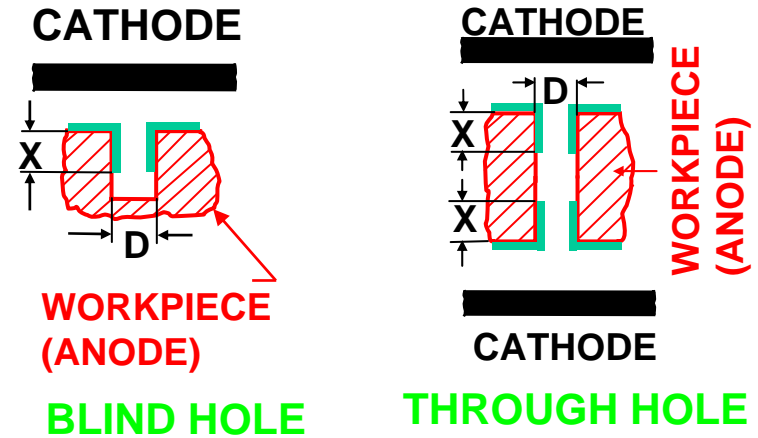
- ❖ **SULFURIC ACID @ TEMPERATURES < TYPE II**
- ❖ **NOT SUITABLE FOR ALLOYS**
 - ❖ **WITH Cu > 5 %**
 - OR**
 - ❖ **WITH Si > 7 %**
- ❖ **THICKNESS: 0.0005-0.0050 IN. (0.5-5.0 MIL)**
- ❖ **FILE HARD- HRC > 60**
 - ❖ **MAY LAP TO DIMENSIONS**
- ❖ **NOT NORMALLY DYED**
- ❖ **NOT SEALED UNLESS OTHERWISE SPECIFIED**
 - ❖ **SMALL PORES**
 - ❖ **SEALING NOT GOOD FOR WEAR PERFORMANCE**



CONVERSION COATINGS

ANODIC COATINGS - ALUMINUM

- ❖ THICKNESS OF ANODIC COATINGS
 - ❖ GENERALLY UNIFORM
 - ❖ MAYBE LITTLE THIN ON EDGES
- ❖ DEEP HOLES MAY NOT BE FULLY COATED
 - ❖ $X = 1.25 D$ (FOR $D < 0.50$ IN)
 - ❖ $X = 1.75 D$ ($D \geq 0.50$ IN)
- ❖ PENETRATION & BUILDUP
 - ❖ AS SHOWN IN BOX



	TYPES I & II *			TYPE III
BUILDUP	1/3 T	2/3 T	1/2 T	1/2 T
PENETRATION	2/3 T	1/3 T	1/2 T	1/2 T

* REFERENCES VARY AS TO PENETRATION AND BUILDUP IN TYPES I & II

CONVERSION COATINGS

MISCELLANEOUS ANODIC COATINGS



- ❖ **OTHER ANODIC PROCESSES USED FOR ALUMINUM**
 - ❖ **PHOSPHORIC**
 - ◆ **TO PROMOTE PLATING OR ADHESIVE BONDING**
 - ❖ **SULFURIC-OXALIC**
 - ◆ **FOR COATING THICKNESS BETWEEN TYPE II & TYPE III**
 - ❖ **SYNERGISTIC (COMPOSITE) : HARD ANODIZE + TEFLON (PTFE)**
 - ◆ **FOR IMPROVED WEAR PERFORMANCE**
 - ◆ **PTFE INFUSED OR CODEPOSITED**
 - ❖ **SELECTIVE (BRUSH) ANODIZING POSSIBLE**
- ❖ **ANODIZING TITANIUM (E.G., TIODIZING)**
 - ❖ **FOR WEAR APPLICATIONS**
 - ❖ **10 % PENETRATION & 90 % BUILDUP-CAN BE BURNISHED**
 - ❖ **DECORATIVE COLORING POSSIBLE**
- ❖ **ANODIZING MAGNESIUM**
 - ❖ **FOR CORROSION PROTECTION OR FOR COLOR (BLACK)**

PLATED & CONVERSION COATINGS DIMENSIONS



- ❖ DRAWING DIMENSIONS TYPICALLY APPLY BEFORE COATING
- ❖ USUALLY, ONLY MINIMUM COATING THICKNESS SPECIFIED
 - ❖ DIMENSIONS BEFORE COATING CONTROLLED BY DRAWING
 - ❖ DIMENSIONS AFTER COATING NOT CONTROLLED
- ❖ TO CONTROL DIMENSIONS AFTER COATING
 - ① ADD MAXIMUM COATING THICKNESS
 - ☒ TO DRAWING OR SPECIFICATION REQUIREMENTS
 - ② ADD AN AFTER COATING SET OF DIMENSIONS
 - ☒ TO DRAWING
 - ⇒ ONLY ONE SET DEPICTED?: IT IS BEFORE COATING
- ❖ PLATED COATINGS CAN BE SO CONTROLLED
 - ① PRECISE THICKNESS CONTROL DURING PLATING
 - ② HARD PLATES: GROUND, HONED OR LAPPED TO DIMENSIONS



PLATED & CONVERSION COATINGS DIMENSIONS

- ❖ **CONVERSION COATINGS CAN NOT BE SO CONTROLLED**
 - ❖ **DUE TO PENETRATION & BUILDUP**
- ❖ **AFTER COATING CONTROL**
 - ① **BLACK OXIDE, CHEMICAL CONVERSION COATINGS**
 - ⊗ **TOO THIN TO WORRY ABOUT**
 - ② **ANODIC ALUMINUM COATINGS**
 - ⊗ **TYPE III (HARD) COATINGS**
 - ⇒ **HONE OR LAP TO DIMENSIONS**
 - ⊗ **TYPES I & II**
 - ⇒ **TOO THIN FOR “SAFE” LAPPING OR HONING**
 - ⇒ **MAY WISH TO EXPERIMENT**
 - ③ **PHOSPHATE COATINGS**
 - ⊗ **HEAVY (2 MIL)- HONE OR LAP TO DIMENSIONS**
 - ⊗ **THIN: MAY WISH TO EXPERIMENT**
 - ④ **ANODIC COATINGS ON OTHER METALS**
 - ⊗ **DEALT WITH ON CASE BY CASE BASIS**
 - ⇒ **E.G., FOR TITANIUM: BURNISH TO DIMENSIONS**

PLATED & CONVERSION COATINGS

HYDROGEN-AGAIN



- ❖ **HYDROGEN EMBRITTLEMENT (H.E.) A CONCERN IN**
 - ❖ **ELECTRO & ELECTROLESS PLATING**
 - ❖ **PHOSPHATE COATINGS**

- ❖ **H.E. ALSO A CONCERN IN**
 - ❖ **NONELECTROLYTIC OPERATIONS IN ACIDS**
 - ◆ **CLEANING, DESCALING, PICKLING, STRIPPING, ETCHING, CHEMICAL-MILLING, ETC.**
 - ❖ **ELECTROLYTIC SURFACE PREPARATION METHODS**
 - ◆ **ELECTROPOLISHING, ELECTROCHEMICAL MACHINING, ETC.**
 - ◆ **ONLY IF WORKPIECE IS CATHODE**
(TYPICALLY, WORKPIECE IS ANODE)
OR
◆ **IF AC IS USED**

- ❖ **H.E. RELIEF PROVISIONS MUST ADDRESS ALL CONCERNS**
 - ❖ **E.G., STRESS RELIEF, PICKLE, BAKE, PLATE, BAKE**

PLATED & CONVERSION COATINGS

SOME MORE HYDROGEN



- ❖ APART FROM STEELS
 - ❖ H.E. IN ALLOYS OTHER THAN STEEL
 - ◆ E.G., Ti & Ni ALLOYS
 - ❖ RELIEF PROCEDURES NOT READILY AVAILABLE
 - ◆ FOR Ti & ALLOYS
 - ◆ 4-6 HRS VACUUM BAKE (10⁻⁴ TORR OR BETTER) @ 1200-1400 F
 - ◆ 375 F NOT ADEQUATE
- ❖ H.E. ALSO
 - ❖ FROM GALVANIC COUPLING
 - ◆ BREAK IN SACRIFICIAL PLATING
- ❖ IF H IS PROBLEM, USE ORGANIC, VACUUM, THERMAL OR MECHANICAL COATINGS

